

NTC thermistors for temperature measurement

Probe assemblies

Series/Type: B57045K Date: March 2013

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Temperature measurement

Probe assemblies

Applications

Temperature compensation, measurement and control (chassis mounting)

Features

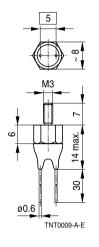
- Cost-effective
- Good thermal coupling through screw-type case (thread M3)
- Electrically isolated aluminum case
- Tinned copper leads

Options

Tighter resistance tolerance available on request.

Delivery mode

Bulk



Dimensional drawing

Dimensions in mm Approx. weight 1 g

General technical data

Climatic category	(IEC 60068-1)		55/125/56	
Max. power	(at 25 °C)	P ₂₅	450	mW
Resistance tolerance		$\Delta R_{R}/R_{R}$	±10	%
Rated temperature		T _R	25	°C
Dissipation factor	(in air)	δ_{th}	approx. 9	mW/K
Dissipation factor	(on chassis)	δ_{th}	approx. 20	mW/K
Thermal cooling time constant	(in air)	τ_{c}	approx. 75	s
Thermal cooling time constant	(on chassis)	τ_{c}	approx. 15	s
Torque			approx. 0.5	Nm
Insulation resistance	(V = 100 V DC)	R _{ins}	> 100	MΩ
Test voltage	(t = 1 s)	V _{test}	2500	V AC

B57045K

Temperature measurement

Probe assemblies

B57045K

K45

Electrical specification and ordering codes

R ₂₅	No. of R/T	B _{25/100}	Ordering code
Ω	characteristic	К	
1 k	1011	3730 ±3%	B57045K0102K000
2.2 k	1013	3900 ±3%	B57045K0222K000
4.7 k	4001	3950 ±3%	B57045K0472K000
6.8 k	2903	4200 ±3%	B57045K0682K000
10 k	2904	4300 ±3%	B57045K0103K000
33 k	1012	4300 ±3%	B57045K0333K000
47 k	4003	4450 ±3%	B57045K0473K000
68 k	2005	4600 ±3%	B57045K0683K000
100 k	2005	4600 ±3%	B57045K0104K000
150 k	2005	4600 ±3%	B57045K0154K000

Reliability data

Test	Standard	Test conditions	$\Delta R_{25}/R_{25}$ (typical)	Remarks
Storage in dry heat	IEC 60068-2-2	Storage at upper category temperature T: 125 °C t: 1000 h	< 3%	No visible damage
Storage in damp heat, steady state	IEC 60068-2-78	Temperature of air: 40 °C Relative humidity of air: 93% Duration: 56 days	< 3%	No visible damage
Endurance		P _{max} : 450 mW t: 1000 h	< 3%	No visible damage
Long-term stability (empirical value)		Temperature: 100 °C t: 10000 h	< 5%	No visible damage

Note

- Contact of NTC thermistors with any liquids and solvents shall be prevented. It must be ensured that no water enters the NTC thermistors (e.g. through plug terminals).
- Avoid dewing and condensation unless thermistor is specified for these conditions.

Temperature measurement

Probe assemblies

R/T characteristics

R/T No.	1011		1012		1013	
T (°C)	B _{25/100} = 3730 K	<u> </u>	B _{25/100} = 4300 K		B _{25/100} = 3900 K	
	R _T /R ₂₅	α (%/K)	R _T /R ₂₅	α (%/K)	R _T /R ₂₅	α (%/K)
-55.0	70.014	6.9	87.237	6.8	77.285	7.0
-50.0	49.906	6.7	62.264	6.7	54.938	6.7
-45.0	36.015	6.4	44.854	6.5	39.507	6.5
-40.0	26.296	6.2	32.599	6.3	28.722	6.3
-35.0	19.411	6.0	23.893	6.1	21.099	6.1
-30.0	14.479	5.8	17.654	6.0	15.652	5.9
-25.0	10.903	5.6	13.098	5.8	11.715	5.7
-20.0	8.2923	5.4	9.8059	5.7	8.8541	5.6
-15.0	6.3591	5.2	7.4266	5.5	6.7433	5.4
-10.0	4.9204	5.1	5.6677	5.4	5.1815	5.2
-5.0	3.8279	4.9	4.3213	5.3	4.0099	5.1
0.0	3.0029	4.8	3.3208	5.1	3.1283	4.9
5.0	2.3773	4.6	2.5842	5.0	2.4569	4.8
10.0	1.8959	4.5	2.0238	4.9	1.9438	4.6
15.0	1.5207	4.3	1.5858	4.8	1.5475	4.5
20.0	1.228	4.2	1.2507	4.7	1.2403	4.4
25.0	1.0000	4.1	1.0000	4.5	1.0000	4.3
30.0	0.81779	3.9	0.7964	4.4	0.81104	4.1
35.0	0.67341	3.8	0.64053	4.3	0.66146	4.0
40.0	0.55747	3.7	0.51772	4.2	0.54254	3.9
45.0 50.0 55.0 60.0 65.0	0.46357 0.3874 0.32368 0.272 0.23041	3.6 3.6 3.5 3.4 3.3	0.41958 0.34172 0.27877 0.22861 0.18872	4.1 4.1 3.9 3.8	0.44727 0.37067 0.30865 0.25825 0.21707	3.8 3.7 3.6 3.5 3.4
70.0	0.19604	3.2	0.15645	3.7	0.18323	3.3
75.0	0.16735	3.1	0.13012	3.6	0.15535	3.3
80.0	0.14342	3.0	0.10863	3.6	0.13223	3.2
85.0	0.12347	3.0	0.091115	3.5	0.11302	3.1
90.0	0.10668	2.8	0.0767	3.4	0.096951	3.0
95.0	0.092734	2.8	0.064867	3.3	0.083487	3.0
100.0	0.080903	2.8	0.055047	3.3	0.072139	2.9
105.0	0.070616	2.7	0.046797	3.2	0.062559	2.8
110.0	0.061826	2.6	0.039904	3.1	0.054425	2.8
115.0	0.054282	2.6	0.034255	3.1	0.047508	2.7
120.0	0.047793	2.5	0.029498	3.0	0.041594	2.6
125.0	0.042249	2.4	0.025448	3.0	0.036532	2.6

Temperature measurement

Probe assemblies

R/T characteristics

R/T No.	2005		2903		2904	
T (°C)	B _{25/100} = 4600 K		B _{25/100} = 4200 K		B _{25/100} = 4300 K	
	R _T /R ₂₅	α (%/K)	R _T /R ₂₅	α (%/K)	R _T /R ₂₅	α (%/K)
-55.0	120.22	7.0	120.03	7.7	121.46	7.4
-50.0	85.48	6.9	82.38	7.4	84.439	7.2
-45.0	61.004	6.8	57.248	7.2	59.243	7.1
-40.0	43.712	6.7	40.255	7.0	41.938	6.9
-35.0	31.459	6.6	28.627	6.7	29.947	6.7
-30.0	22.746	6.6	20.577	6.6	21.567	6.6
-25.0	16.49	6.4	14.876	6.4	15.641	6.3
-20.0	12.071	6.3	10.88	6.1	11.466	6.2
-15.0	8.8455	6.1	8.0808	5.9	8.451	6.0
-10.0	6.5446	6.0	6.0612	5.8	6.2927	5.9
-5.0	4.8852	5.8	4.5649	5.6	4.7077	5.7
0.0	3.6781	5.6	3.4708	5.4	3.5563	5.5
5.0	2.7944	5.4	2.6625	5.2	2.7119	5.3
10.0	2.1391	5.3	2.0599	5.1	2.086	5.1
15.0	1.6507	5.1	1.6069	4.9	1.6204	5.0
20.0	1.2823	5.1	1.2631	4.8	1.2683	4.8
25.0	1.0000	5.0	1.0000	4.6	1.0000	4.7
30.0	0.78393	4.8	0.79593	4.5	0.7942	4.6
35.0	0.61822	4.7	0.63796	4.4	0.63268	4.5
40.0	0.49053	4.6	0.51467	4.2	0.5074	4.3
45.0	0.39116	4.5	0.41887	4.1	0.41026	4.2
50.0	0.31371	4.3	0.34272	4.0	0.33363	4.1
55.0	0.25338	4.2	0.28081	3.9	0.27243	4.0
60.0	0.20565	4.2	0.23141	3.8	0.2237	3.9
65.0	0.16762	4.1	0.19211	3.7	0.18459	3.8
70.0	0.13726	4.0	0.16027	3.6	0.15305	3.7
75.0	0.11279	3.9	0.13421	3.5	0.12755	3.6
80.0	0.093053	3.8	0.11288	3.4	0.10677	3.5
85.0	0.077177	3.7	0.095326	3.3	0.089928	3.4
90.0	0.064263	3.6	0.080828	3.2	0.076068	3.3
95.0	0.053678	3.6	0.068916	3.2	0.064524	3.3
100.0	0.044996	3.5	0.058989	3.1	0.054941	3.2
105.0	0.037917	3.4	0.050701	3.0	0.047003	3.1
110.0	0.032063	3.4	0.043735	3.0	0.040358	3.0
115.0	0.027161	3.3	0.037778	2.9	0.034743	3.0
120.0 125.0 130.0 135.0 140.0	0.023079 0.01968 - - -	3.2 3.2 - -	0.032736 0.028513 -	2.8 2.7 - -	0.030007 0.026006 0.022609 0.01972 0.017251	2.9 2.8 2.8 2.7 2.6
145.0	-	_	-	_	0.015139	2.6
150.0	-	_	-	_	0.013321	2.5
155.0	-	_	-	_	0.011754	2.5

Temperature measurement

Probe assemblies

R/T characteristics

R/T No.	4001		4003	
T (°C)	B _{25/100} = 3950 K		B _{25/100} = 4450 K	
	R _T /R ₂₅	α (%/K)	R _T /R ₂₅	α (%/K)
-55.0	88.052	7.3	103.81	6.8
-50.0	61.65	7.0	73.707	6.7
-45.0	43.727	6.8	52.723	6.6
-40.0	31.395	6.5	37.988	6.5
-35.0	22.802	6.3	27.565	6.4
-30.0	16.742	6.2	20.142	6.2
-25.0	12.367	6.0	14.801	6.1
-20.0	9.2353	5.6	10.976	5.9
-15.0	7.0079	5.4	8.1744	5.8
-10.0	5.3654	5.4	6.1407	5.7
-5.0	4.126	5.2	4.6331	5.5
0.0	3.2	5.0	3.5243	5.4
5.0	2.4986	4.9	2.6995	5.3
10.0	1.9662	4.7	2.0831	5.1
15.0	1.5596	4.6	1.6189	5.0
20.0	1.2457	4.5	1.2666	4.9
25.0	1.0000	4.4	1.0000	4.7
30.0	0.80355	4.2	0.78351	4.6
35.0	0.65346	4.1	0.62372	4.5
40.0	0.53456	4.0	0.49937	4.4
45.0	0.43966	3.9	0.40218	4.3
50.0	0.36357	3.8	0.32557	4.2
55.0	0.30183	3.7	0.26402	4.1
60.0	0.25189	3.6	0.21527	4.0
65.0	0.21136	3.5	0.17693	3.9
70.0	0.17819	3.4	0.14616	3.8
75.0	0.15089	3.3	0.12097	3.7
80.0	0.12833	3.2	0.10053	3.7
85.0	0.10948	3.1	0.083761	3.6
90.0	0.093748	3.0	0.070039	3.5
95.0	0.080764	2.9	0.058937	3.4
100.0	0.069842	2.9	0.049777	3.4
105.0	0.060455	2.9	0.042146	3.3
110.0	0.052498	2.8	0.035803	3.2
115.0	0.04574	2.7	0.030504	3.2
120.0 125.0 130.0 135.0 140.0	0.039972 0.034984 - - -	2.7 2.6 - -	0.026067 0.022332 0.019186 0.016515 0.014253	3.1 3.0 3.0 2.9 2.9
145.0	-		0.012367	2.8
150.0	-		0.010758	2.8
155.0	-		0.0093933	2.7

B57045K

Temperature measurement

Probe assemblies

Cautions and warnings

See "Important notes".

Storage

- Store thermistors only in original packaging. Do not open the package prior to storage.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, <95% maximum 30 days per annum, dew precipitation is inadmissible.</p>
- Do not store thermistors where they are exposed to heat or direct sunlight. Otherwise, the packing material may be deformed or components may stick together, causing problems during mounting.
- Avoid contamination of thermistor surface during storage, handling and processing.
- Avoid storage of thermistors in harmful environments like corrosive gases (SO_x, Cl etc).
- Use the components as soon as possible after opening the factory seals, i.e. the polyvinyl-sealed packages.
- Solder thermistors within the time specified after shipment from EPCOS. For leaded components this is 24 months, for SMD components with nickel barrier termination 12 months, for SMD components with AgPd termination 6 months.

Handling

- NTC thermistors must not be dropped. Chip-offs or any other damage must not be caused during handling of NTCs.
- Do not touch components with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.
- Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

Bending / twisting leads

- A lead (wire) may be bent at a minimum distance of twice the wire's diameter plus 4 mm from the component head or housing. When bending ensure the wire is mechanically relieved at the component head or housing. The bending radius should be at least 0.75 mm.
- Twisting (torsion) by 180° of a lead bent by 90° is permissible at 6 mm from the bottom of the thermistor body.

Soldering

- Use resin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.

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Temperature measurement

Probe assemblies

K45

Mounting

- Ensure that no thermo-mechanical stress occurs due to production processes (curing or overmolding processes) when thermistors are sealed, potted or overmolded or during their subsequent operation. The maximum temperature of the thermistor must not be exceeded. Ensure that the materials used (sealing/potting compound and plastic material) are chemically neutral.
- Electrodes/contacts must not be scratched or damaged before/during/after the mounting process.
- Contacts and housing used for assembly with the thermistor must be clean before mounting.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of the thermistor. Be sure that surrounding parts and materials can withstand the temperature.
- Avoid contamination of the thermistor surface during processing.
- The connections of sensors (e.g. cable end, wire end, plug terminal) may only be exposed to an environment with normal atmospheric conditions.
- Tensile forces on cables or leads must be avoided during mounting and operation.
- Bending or twisting of cables or leads directly on the thermistor body is not permissible.
- Avoid using chemical substances as mounting aids. It must be ensured that no water or other liquids enter the NTC thermistors (e.g. through plug terminals). In particular, water based substances (e.g. soap suds) must not be used as mounting aids for sensors.

Operation

- Use thermistors only within the specified operating temperature range.
- Use thermistors only within the specified power range.
- Environmental conditions must not harm the thermistors. Only use the thermistors under normal atmospheric conditions or within the specified conditions.
- Contact of NTC thermistors with any liquids and solvents shall be prevented. It must be ensured that no water enters the NTC thermistors (e.g. through plug terminals). For measurement purposes (checking the specified resistance vs. temperature), the component must not be immersed in water but in suitable liquids (e.g. Galden).
- Avoid dewing and condensation unless thermistor is specified for these conditions.
- Bending or twisting of cables and/or wires is not permissible during operation of the sensor in the application.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by malfunction.

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

Temperature measurement

Probe assemblies

K45

Symbols and terms

Symbol	English	German
А	Area	Fläche
AWG	American Wire Gauge	Amerikanische Norm für Drahtquerschnitte
В	B value	B-Wert
B _{25/100}	B value determined by resistance	B-Wert, ermittelt durch Widerstands-
	measurement at 25 °C and 100 °C	messungen bei 25 °C und 100 °C
C _{th}	Heat capacitance	Wärmekapazität
I	Current	Strom
Ν	Number (integer)	Anzahl (ganzzahliger Wert)
P ₂₅	Maximum power at 25 °C	Maximale Leistung bei 25 °C
P_{diss}	Power dissipation	Verlustleistung
P _{el}	Electrical power	Elektrische Leistung
P _{max}	Maximum power within stated	Maximale Leistung im
	temperature range	angegebenenTemperaturbereich
$\Delta R_{\rm B}/R_{\rm B}$	Resistance tolerance caused by	Widerstandstoleranz, die durch die
	spread of B value	Streuung des B-Wertes verursacht wird
R _{ins}	Insulation resistance	Isolationswiderstand
R₽	Parallel resistance	Parallelwiderstand
R _R	Rated resistance	Nennwiderstand
$\Delta R_R/R_R$	Resistance tolerance	Widerstandstoleranz
Rs	Series resistance	Serienwiderstand
R _τ	Resistance at temperature T	Widerstand bei Temperatur T
	(e.g. R_{25} = resistance at 25 °C)	(z.B. R_{25} = Widerstand bei 25 °C)
Т	Temperature	Temperatur
ΔT	Temperature tolerance	Temperaturtoleranz
t 	Time	Zeit
T _A	Ambient temperature	Umgebungstemperatur
T _{max}	Upper category temperature	Obere Grenztemperatur
T _{min}	Lower category temperature	(Kategorietemperatur) Untere Grenztemperatur
I min	Lower category temperature	(Kategorietemperatur)
т	Operating temperature	
Т _{ор} Тв	Operating temperature Rated temperature	Betriebstemperatur Nenntemperatur
T _{surf}	Surface temperature	Oberflächentemperatur
V	Voltage	Spannung
V _{ins}	Insulation test voltage	Isolationsprüfspannung
V _{op}	Operating voltage	Betriebsspannung
V _{test}	Test voltage	Prüfspannung

Temperature measurement

Probe assemblies

Symbol	English	German
α	Temperature coefficient	Temperaturkoeffizient
Δ	Tolerance, change	Toleranz, Änderung
δ_{th}	Dissipation factor	Wärmeleitwert
τ_{c}	Thermal cooling time constant	Thermische Abkühlzeitkonstante
τ_{a}	Thermal time constant	Thermische Zeitkonstante

Abbreviations / Notes

Symbol	English	German
SMD	Surface-mounted devices	Oberflächenmontierbares Bauelement
*	To be replaced by a number in ordering codes, type designations etc.	Platzhalter für Zahl im Bestellnummern- code oder für die Typenbezeichnung.
+	To be replaced by a letter.	Platzhalter für einen Buchstaben.
	All dimensions are given in mm.	Alle Maße sind in mm angegeben.
	The commas used in numerical values denote decimal points.	Verwendete Kommas in Zahlenwerten bezeichnen Dezimalpunkte.

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 521

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 1-1423022-3
 MF0916001M4BP0FPT0
 MF58-5.91KF3820-B1
 04M5002SFA4
 NCG18WF104F0SRB

 NXFT15WF104FEAB035
 NXFT15WF104FEAB040
 NXFT15XV103FEAB030
 NXFT15XV103FEAB025
 NXFT15XV103FEAB040

 NXFT15XH103FEAB050
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 NXFT15XV103FEAB021
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 TCTR0805F10K0F3720T

 TCTR0603F100KF44607
 TCTR0603F100KF4390T
 TCTR0603F100KF4050T
 TCTR0603F100KF3980T
 TCTR0603F10K0F3980T